

POWERTIP TECH. CORP.

DISPLAY DEVICES FOR BETTER ELECTRONIC DESIGN

Specification For Approval

Customer : _____

Model Type : LCD MODULE

Sample Code : _____

Mass Production Code : PG240128WRM-ATA-IY6

Edition : 0

Customer Sign	Sales Sign	Checked By (QA)	Approved By	Prepared By
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Revision Record

Date(y/m/d)	Rev.	Description	Note	Page
2003/04/09	0	Revised Contents		

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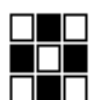
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1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	240 * 128 dots
LCD Type	STN, Blue, Transmissive, Negative, Extended Temp.
Driver Type	1/128 Duty , 1/12 Bias
Viewing Direction	6 O' clock
Backlight	White LED B/L
Weight	-
Other	-

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	152.0(L) * 104.0(w) * 14.3(H)(Max)	mm
Viewing Area	114.0(L) * 64.0(w)	mm
Active Area	107.95(L) * 57.55(w)	mm
Dot Size	0.40(L) * 0.40(w)	mm
Dot Pitch	0.45(L) * 0.45(w)	mm

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V _{DD}	-	-0.3	7.0	V
Input Voltage	V _{IN}	-	-0.3	V _{DD} +0.3	V
Operating Temperature	T _{OP}	-	-20	70	°C
Storage Temperature.	T _{ST}	-	-30	80	°C
Humidity	H _D	-	-	90	%RH



1.4 DC Electrical Characteristics

 $V_{DD} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0\text{V}$, $T_a = 25^\circ\text{C}$

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Logic Supply Voltage	V_{DD}	-	4.5	5.0	5.5	V
“H” Input Voltage	V_{IH}	-	$V_{DD}-2.2$	-	V_{DD}	V
“L” Input Voltage	V_{IL}	-	0	-	0.8	V
“H” Output Voltage	V_{OH}	-	$V_{DD}-0.3$	-	V_{DD}	V
“L” Output Voltage	V_{OL}	-	0	-	0.3	V
Operating Frequency	f_{osc}	-	-	6	-	MHz
Supply Current	I_{DD}	$V_{DD} = 5.0 \text{ V}$ $f_{OSC}=3.0\text{MHz}$	-	55	-	mA
LCD Driver Voltage	V_{OP}	$V_{DD} - V_O (-20^\circ\text{C})$	-	-	-	V
		$V_{DD} - V_O (25^\circ\text{C})$	-	17.5	-	
		$V_{DD} - V_O (70^\circ\text{C})$	-	-	-	

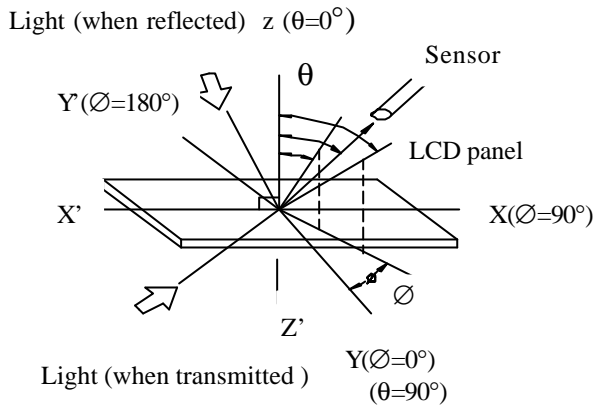
1.5 Optical Characteristics

 $1/128\text{Duty}$, $1/12\text{Bias}$, $V_{OP} = 17.5 \text{ V}$, $T_a = 25^\circ\text{C}$

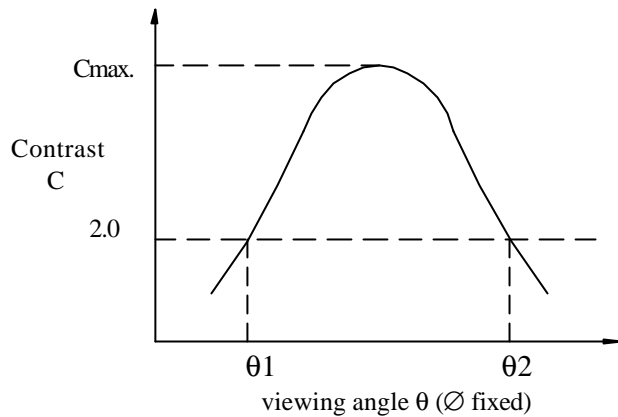
Item	Symbol	Conditions	Min.	Typ.	Max.	Reference
View Angle	θ	$C \geq 2.0, \varnothing = 0^\circ$	40°	-	-	Notes 1 & 2
Contrast Ratio	C	$\theta = 5^\circ, \varnothing = 0^\circ$	-	3	-	Note 3
Response Time(rise)	T_r	$\theta = 5^\circ, \varnothing = 0^\circ$	-	200 ms	300 ms	Note 4
Response Time(fall)	T_f	$\theta = 5^\circ, \varnothing = 0^\circ$	-	250 ms	380 ms	Note 4



Note 1: Definition of angles θ and \varnothing



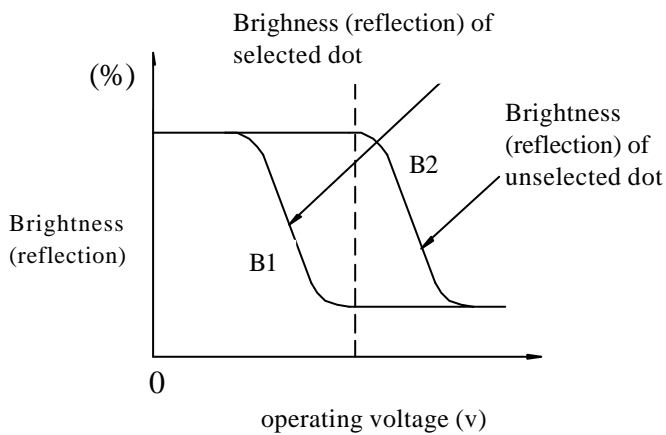
Note 2: Definition of viewing angles θ_1 and θ_2



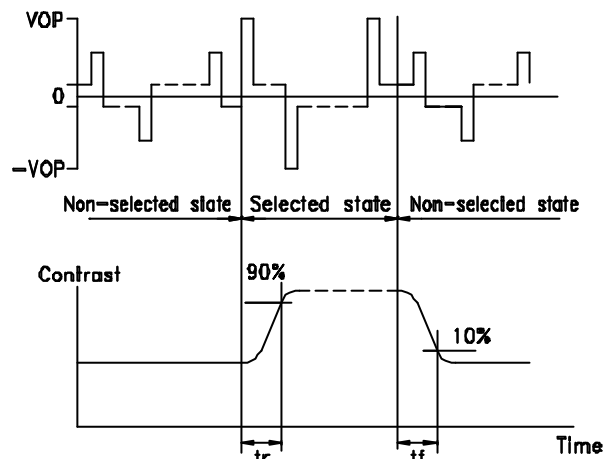
Note : Optimum viewing angle with the naked eye and viewing angle θ at C_{max} . Above are not always the same

Note 3: Definition of contrast C

$$C = \frac{\text{Brightness (reflection) of unselected dot (B2)}}{\text{Brightness (reflection) of selected dot (B1)}}$$



Note 4: Definition of response time



Note: Measured with a transmissive LCD panel which is displayed 1 cm²

V_{OPR} : Operating voltage
 t_r : Response time (rise)

f_{FRM} : Frame frequency
 t_f : Response time (fall)



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1.6 Backlight Characteristics

LCD Module with LED Backlight

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward current	IF	TA=25°C	-	150	mA
Reverse voltage	VR	TA=25°C	-	5	V
Power dissipation	PD	TA=25°C	-	0.8	W
Operating Temperature	TOPR	-	-20	70	°C
Storage temperature	TSTG	-	-40	80	°C

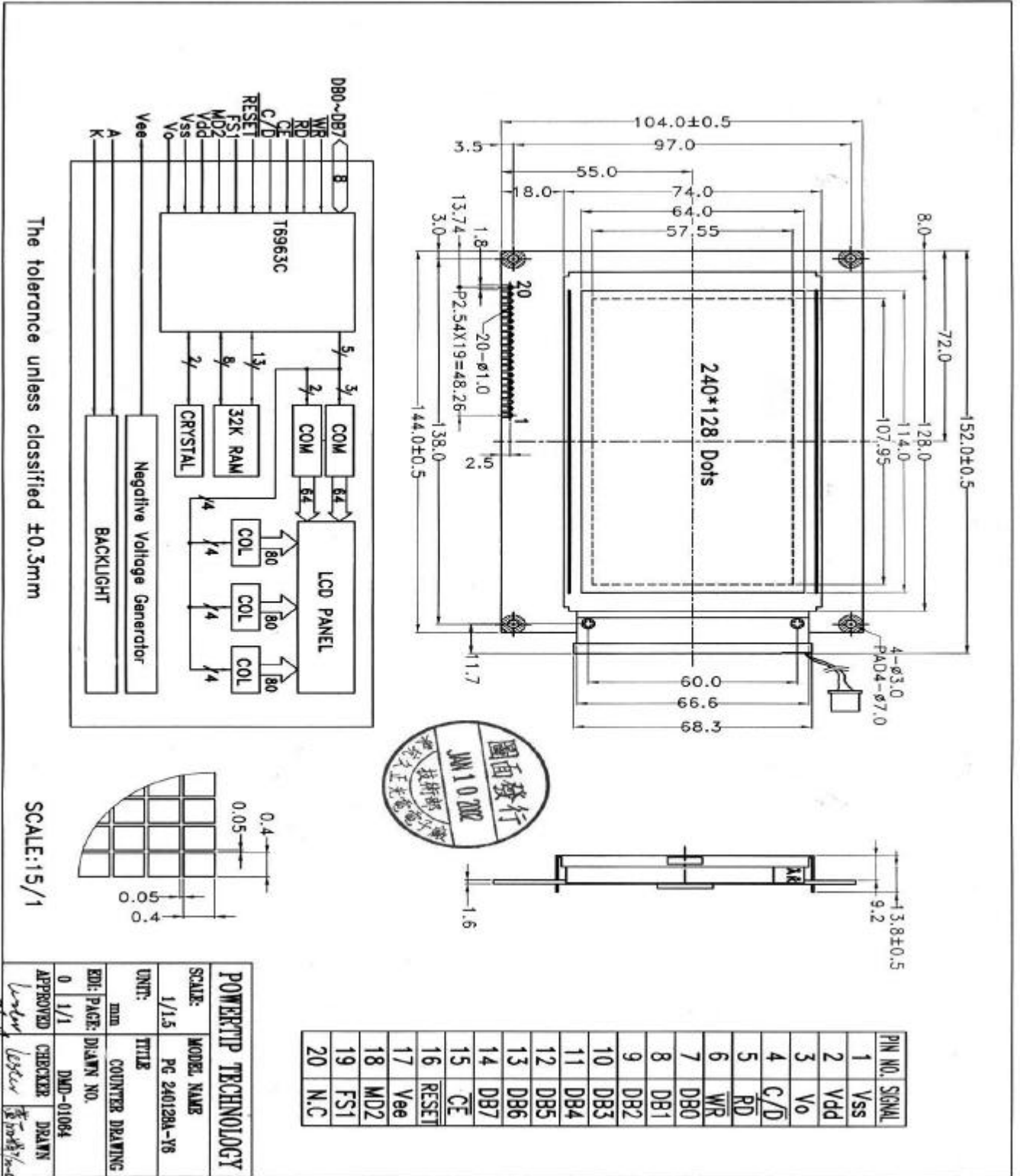
Electrical Ratings

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward voltage	VF	IF=120mA	-	3.5	4.0	V
Reverse current	IR	VR=8V	-	-	10	mA
Luminous intensity	IV	IF=120mA	-	70	-	cd/m ²
Chromaticity Coordinates	X	IF=120mA	-	0.28	-	-
	Y		-	0.29	-	
Color	White					



2. MODULE STRUCTURE

2.1 Counter Drawing

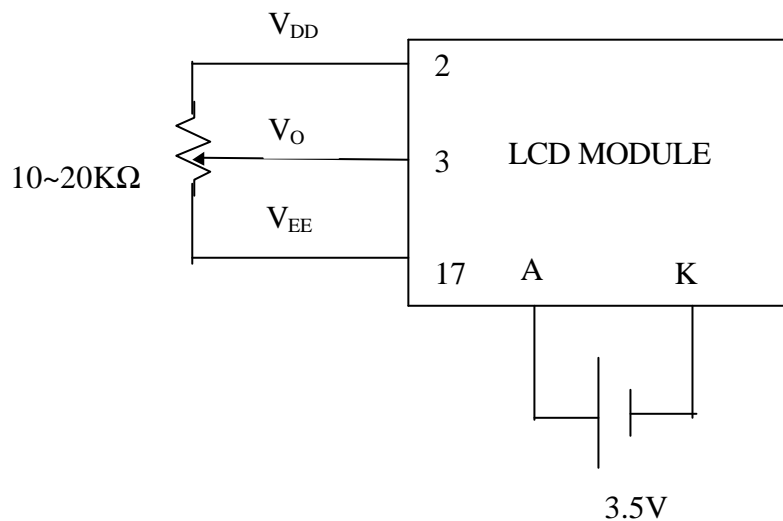


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2.2 Interface Pin Description

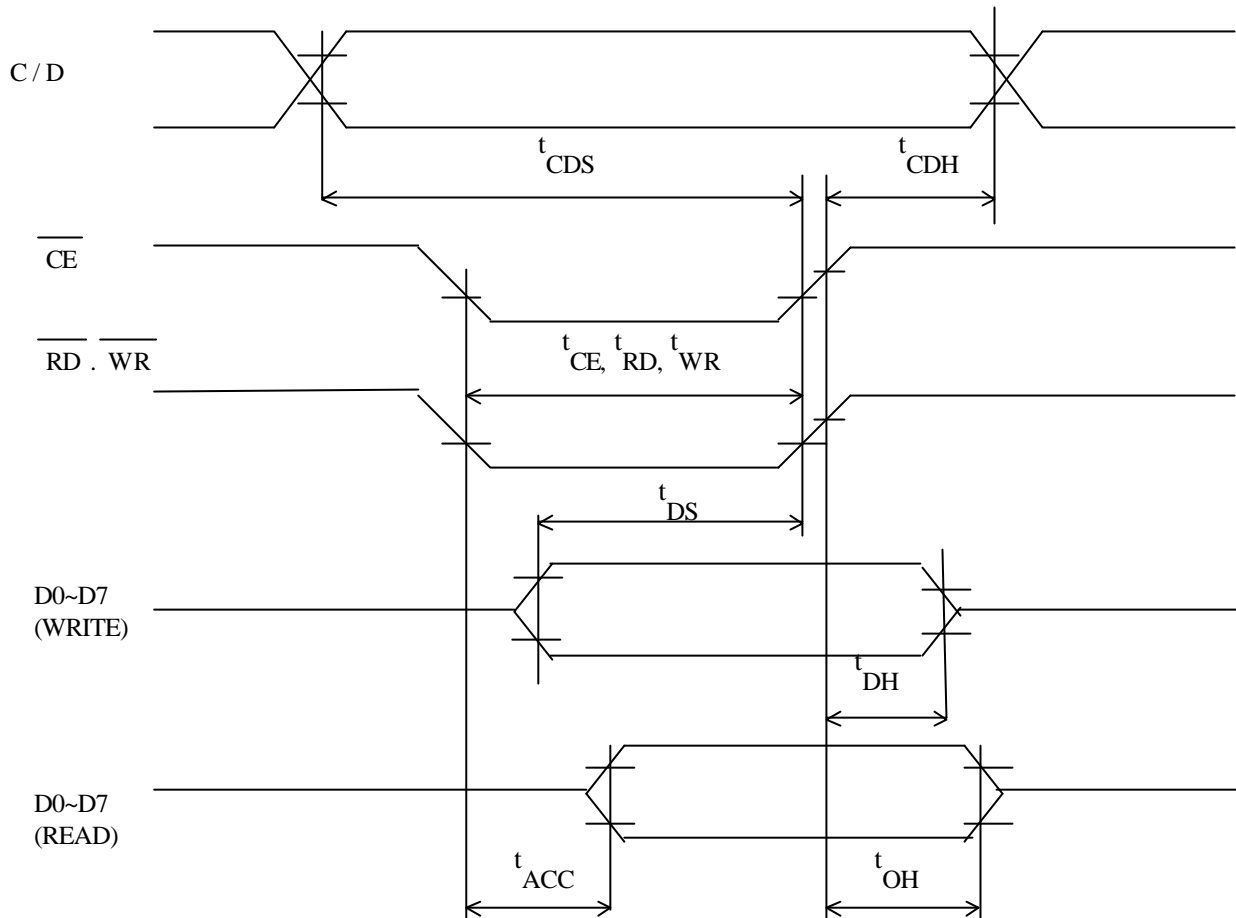
Pin No.	Symbol	Function
1	V_{SS}	Power Supply ($V_{SS}=0$)
2	V_{DD}	Power Supply ($V_{DD}>V_{SS}$)
3	V_0	Operating voltage (LCD Driver)
4	$\overline{C/D}$	$\overline{WR} = "L"; \overline{C/D} = "H"$:command write, $\overline{C/D} = "L"$:data write $\overline{RD} = "L"; \overline{C/D} = "H"$:command read, $\overline{C/D} = "L"$:data read
5	\overline{RD}	Data read (read data from the module at "L")
6	\overline{WR}	Data write (write data to the module at "L")
7~14	DB0~DB7	Data bus (DB0=MSB, DB7=LSB)
15	\overline{CE}	Chip enable for the module (active at "L")
16	\overline{RESET}	Controller reset (module reset)
17	V_{EE}	Power supply for LCD drive (build in)
18	MD2	Columns select ; connect to V_{DD} :32 columns connect to V_{SS} :40 columns
19	FS1	Font select :open or connect to V_{DD} : 6*8 Dots font connect to V_{SS} : 8*8 Dots font
20	NC	Not connection

Contrast Adjust



2.3 Timing Characteristics

Bus Timing



Unless otherwise noted, $V_{DD}=5.0V\pm 10\%$, $V_{SS}=0V$, $T_a=25$

ITEM	SYMBOL	TEST CONDITION	MIN.	MAX.	UNIT
C/D Set Up Time	t_{CDS}	-	100	-	ns
C/D Hold Time	t_{CDH}	-	10	-	ns
CE, RD, WR Pulse Width	t_{CE}, t_{RD}, t_{WR}	-	80	-	ns
Data Set Up Time	t_{DS}	-	80	-	ns
Data Hold Time	t_{DH}	-	40	-	ns
Access Time	t_{ACC}	-	-	150	ns
Output Hold Time	t_{OH}	-	10	50	ns



2.4 Display command

1.Register Set

Code	Hex.	Function	D1	D2
00100001	21H	Cursor pointer set	X ADRS	Y ADRS
00100010	22H	Offset register set	Data	00H
00100100	24H	Address pointer set	Low ADRS	High ADRS

(1) Cursor pointer set

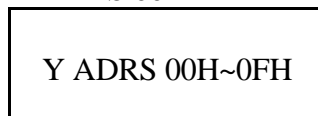
The position of cursor is specified by X ADRS, Y ADRS. The cursor position is moved only by this command. The cursor pointer doesn't have the function of increment and decrement. The shift of cursor are set by this command. X ADRS, Y ADRS are specified following.

X ADRS 00H~4FH (Lower 7bits are valid)

Y ADRS 00H~1FH (Lower 5 bits are valid)

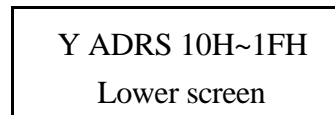
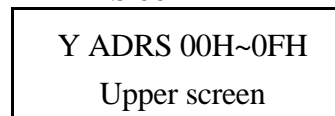
1. 1 screen drive

X ADRS 00~4FH



2. 2 screens drive

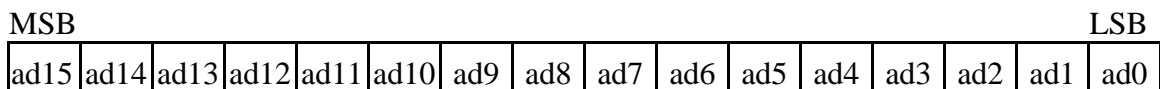
X ADRS 00~4FH



(2) Offset register set

The offset register is used to determine external character generator RAM area.

T693C has 16 bit address lines as follow.



The upper 5 bit (ad15~ad11) are determined by offset register. The middle 8 bit (ad10~ad3) are determined by character code. The lower 3 bit (ad2~ad0) are determined by vertical counter. The lower 5 bit of D1 (data) are valid.

The data format of external character generator RAM.



The relationship of display RAM address and offset register

Data of offset register	CG RAM HEX. Address (start-end)
00000	0000-07FFH
00001	0800-0FFFH
00010	1000-17FFH
11100	E000-E7FFH
11101	E800-EFFFH
11110	F000-F7FFH
11111	F800-FFFFH

(Example 1)

Offset register 02H
 Character code 80H
 Character generator RAM start address 0001 0100 0000 0000
 1 4 0 0 H

(Address)	(Data)
1400H	00H
1401H	1FH
1402H	04H
1403H	04H
1404H	04H
1405H	04H
1406H	04H
1407H	00H

(Example 2) The relationship of display RAM data and display character

(RAM DATA)	(Character)
21H	A
22H	B
83H	γ
24H	D
25H	E
86H	

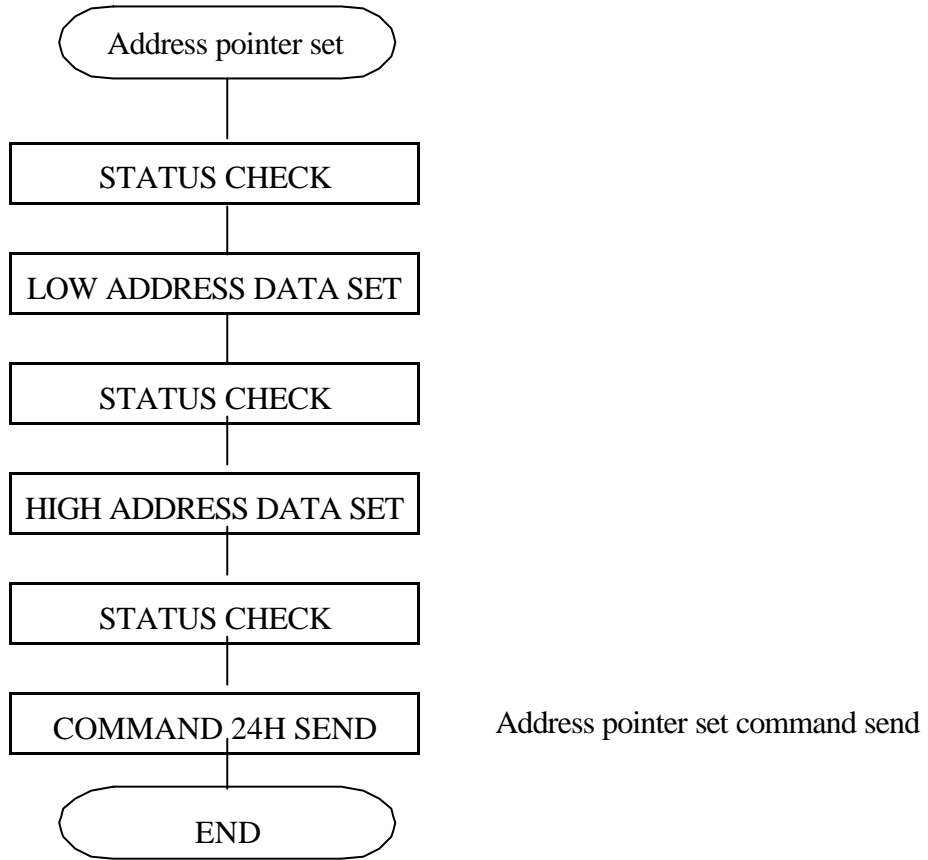
γ and are displayed by character generator RAM.



(3)Address pointer set

The address pointer set command is used to indicate the start address for writing (or reading) to external RAM.

The flow chart address pointer set command



2.Control word set

Code	Hex.	Function	D1	D2
01000000	40H	Text home address set	Low address	High address
01000001	41H	Text area set	Columns	00H
01000010	42H	Graphic home address set	Low address	High address
01000011	43H	Graphic area set	Columns	00H

The home address and column size are defined by this command.



(1)Text home address set

The starting address of external display RAM for Text display is defined by this command. The text home address shows the left end and most upper position.

The relationship of external display RAM address and display position

TH		TH+CL
TH+TA		TH+TA+CL
(TH+TA)+TA		TH+2TA+CL
(TH+2TA)+TA		TH+3TA+CL
TH+(n-1)TA		TH+(n-1)TA+CL

TH : Text home address

TA : Text area number (columns)

CL : Columns are fixed by hardware. (pin-programmable)

(Example)

Text home address : 0000H
 Text area : 0020H
 MD2=H, MD3=H : 32 columns
 DUAL=H, MDX=L, MD1=H : 4 lines

0000H	0001H		001EH	001FH
0020H	0021H		003EH	003FH
0040H	0041H		005EH	005FH
0060H	0061H		007EH	007FH

(2)Graphic home address set

The starting address of external display RAM for Graphic display is defined by this command. The Graphic home address show the left end most upper line.

The relationship of external display RAM address and display position

GH		GH+CL
GH+GA		GH+GA+CL
(GH+GA)+GA		GH+2GA+CL
(GH+2GA)+GA		GH+3GA+CL
GH+(n-1)GA		GH+(n-1)GA+CL

GH : Graphic home address

GA : Graphic area number (columns)

CL : Columns area fixed by hardware. (pin-programmable)



(Example)

Graphic home address : 0000H
 Graphic area : 0020H
 MD2=H, MD3=H : 32 columns
 DUAL =H, MDS=L, MD0=H, MD1=H : 2 lines

0000H	0001H		001EH	001FH
0020H	0021H		003EH	003FH
0040H	0041H		005EH	005FH
0060H	0061H		007EH	007FH
0080H	0081H		009EH	009FH
00A0H	00A1H		00BEH	00BFH
00C0H	00C1H		00DEH	00DFH
00E0H	00E1H		00FEH	00FFH
0100H	0101H		011EH	011FH
0120H	0121H		013EH	013FH
0140H	0141H		015EH	015FH
0160H	0161H		017EH	017FH
0180H	0181H		019EH	019FH
01A0H	01A1H		01BEH	01BFH
01C0H	01C1H		01DEH	01DFH
01E0H	01E1H		01FEH	01FFH


(3)Text area set

The columns of display are defined by the hardware setting. This command can be used to adjust columns of display.

(Example)

LCD size : 20 columns, 4 lines
 Text home address : 0000H
 Text area : 0014H
 MD2=H, MD3=H : 32 columns
 DUAL=H, MDS=L, MD0=L, MD1=H : 4 lines

0000	0001	0013	0014	001F
0014	0015	0027	0028	0033
0028	0029	003B	003C	0047
003C	003D	004F	0050	005B


 LCD



(4)Graphic area set

The columns of display are defined by the hardware setting. This command can be used to adjust columns of graphic display.

(Example)

LCD size : 20 columns, 2 lines
 Text home address : 0000H
 Text area : 0014H
 MD2=H, MD3=H : 32 columns
 DUAL=H, MDS=L, MDD=H, MD1=H : 2 lines

0000	0001	0013	0014	001F
0014	0015	0027	0028	0033
0028	0029	003B	003C	0047
003C	003D	004F	0050	005B
0050	0051	0063	0064	006F
0064	0065	0077	0078	0083
0078	0079	008B	008C	0097
008C	008D	009F	00A0	00AB
00A0	00A1	00B3	00B4	00BF
00B4	00B5	00C7	00C8	00D3
00C8	00C9	00DB	00DC	00E7
00DC	00DD	00EF	00F0	00FD
00F0	00F1	0103	0104	011F
0104	0105	0127	0128	0123
0128	0129	013B	013C	0147
013C	013D	014F	0150	0158

The address in graphic area can be continuous and RAM area can be used without ineffective area, if graphic area is defined the same number as the actual column number of LCD display.



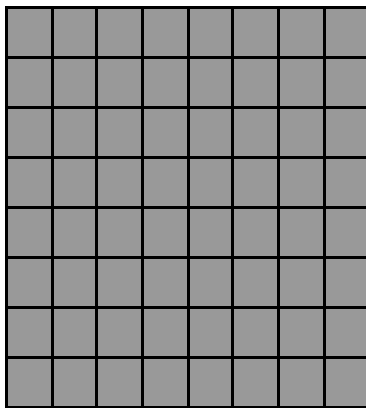
3.Mode set

Code	Function	Operand
1000x000	“OR” Mode	-
1000x001	“EXOR” Mode	-
1000x011	“AND” Mode	-
1000x100	“TEXT ATTRIBUTE” Mode	-
10000xxx	Internal Character Generator Mode	-
10001xxx	External Character Generator Mode	-

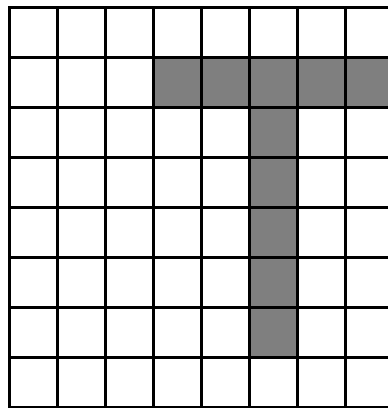
The display mode is defined by this command. The display mode don't have changed until to send next this command. Logically “OR”, “EXOR”, “AND” of text and graphic display can be displayed.

When internal character generator mode is selected, character code 00H~7FH are selected from built-in character generator ROM. The character code 80H~FFH are automatically selected external character generator RAM.

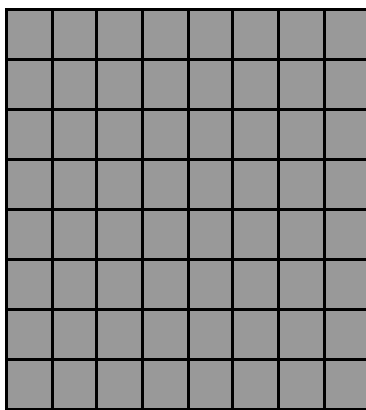
(Example)



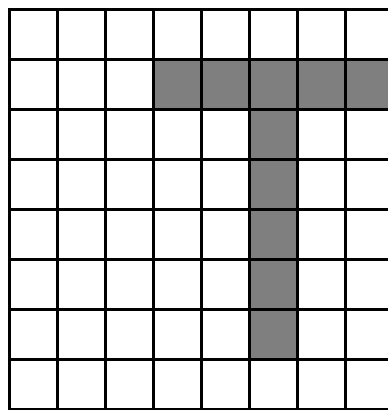
Graphic



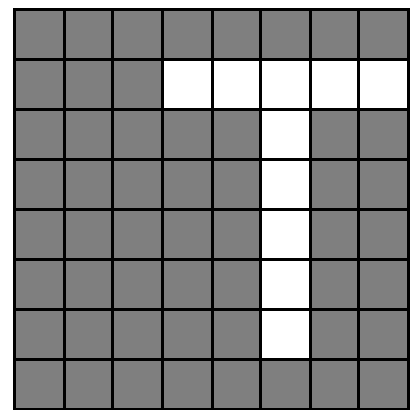
Text



“OR”



“AND”



“EXOR”

Note: Only text display is attributed, because attribute data is located in graphic RAM area.

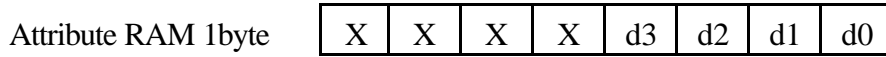


Attribute function

“Reverse display” , “Character blink” and “Inhibit” are called “Attribute”. The attribute data is written in the graphic area defined by Control word set command.

The mode set command selects text display only and graphic display cannot be displayed.

The attribute data of the 1st character in text area is written at the 1st 1byte in graphic area, and attribute data of n-th character is written at the n-th 1byte in graphic area. Attribute function is defined as follow.

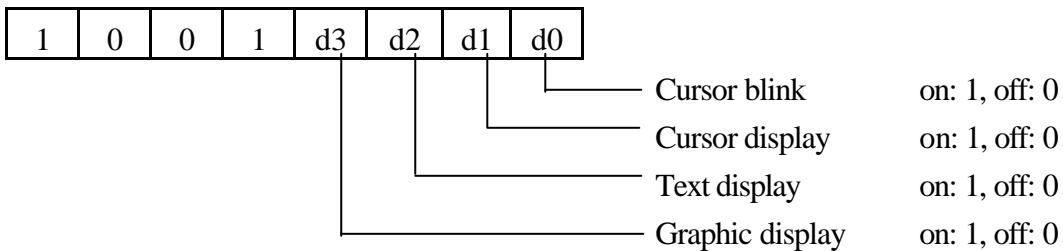


d3	d2	d1	d0	Function
0	0	0	0	Normal display
0	1	0	1	Reverse display
0	0	1	1	Inhibit display
1	0	0	0	Blink of normal display
1	1	0	1	Blink of reverse display
1	0	1	1	Blink of inhibit display

X : Don't care

4.Display mode

Code	Function	Operand
10010000	Display off	-
1001xx10	Cursor on , blink off	-
1001xx11	Cursor on , blink on	-
100101xx	Text on, graphic off	-
100110xx	Text off, graphic on	-
100111xx	Text on , graphic on	-



Note: It is necessary to turn on “Text display” and “ Graphic display “ in following case.

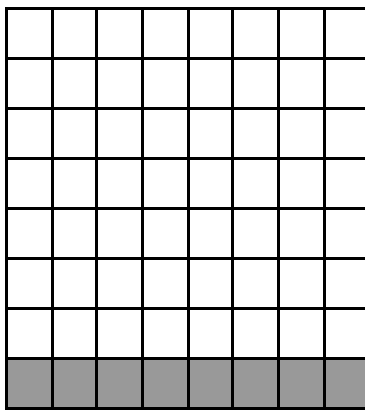
- (1) Combination of text/graphic display
- (2) Attribute function



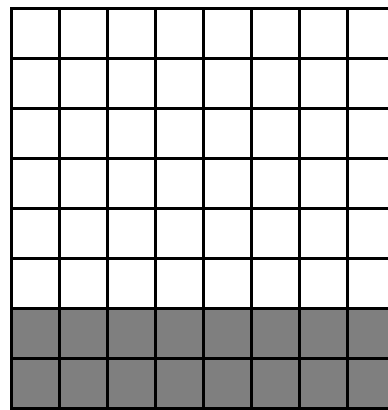
5.Cursor pattern select

Code	Function	Operand
10100000	1 line cursor	-
10100001	2 lines cursor	-
10100010	3 lines cursor	-
10100011	4 lines cursor	-
10100100	5 lines cursor	-
10100101	6 lines cursor	-
10100110	7 lines cursor	-
10100111	8 lines cursor	-

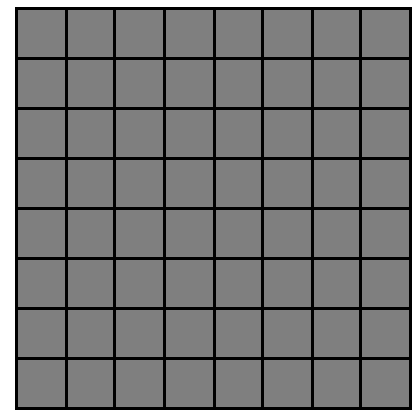
When cursor display is ON, this command selects the cursor pattern from 1 line to 8 lines. The cursor address is defined by cursor pointer set command.



1 line cursor



2 lines cursor



8 lines cursor

6.Data auto read/write

Code	Hex.	Function	Operand
10110000	B0H	Data auto write set	-
10110001	B1H	Data auto read set	-
10110010	B2H	Auto reset	-

This command is convenient to send full screen data from external display RAM.

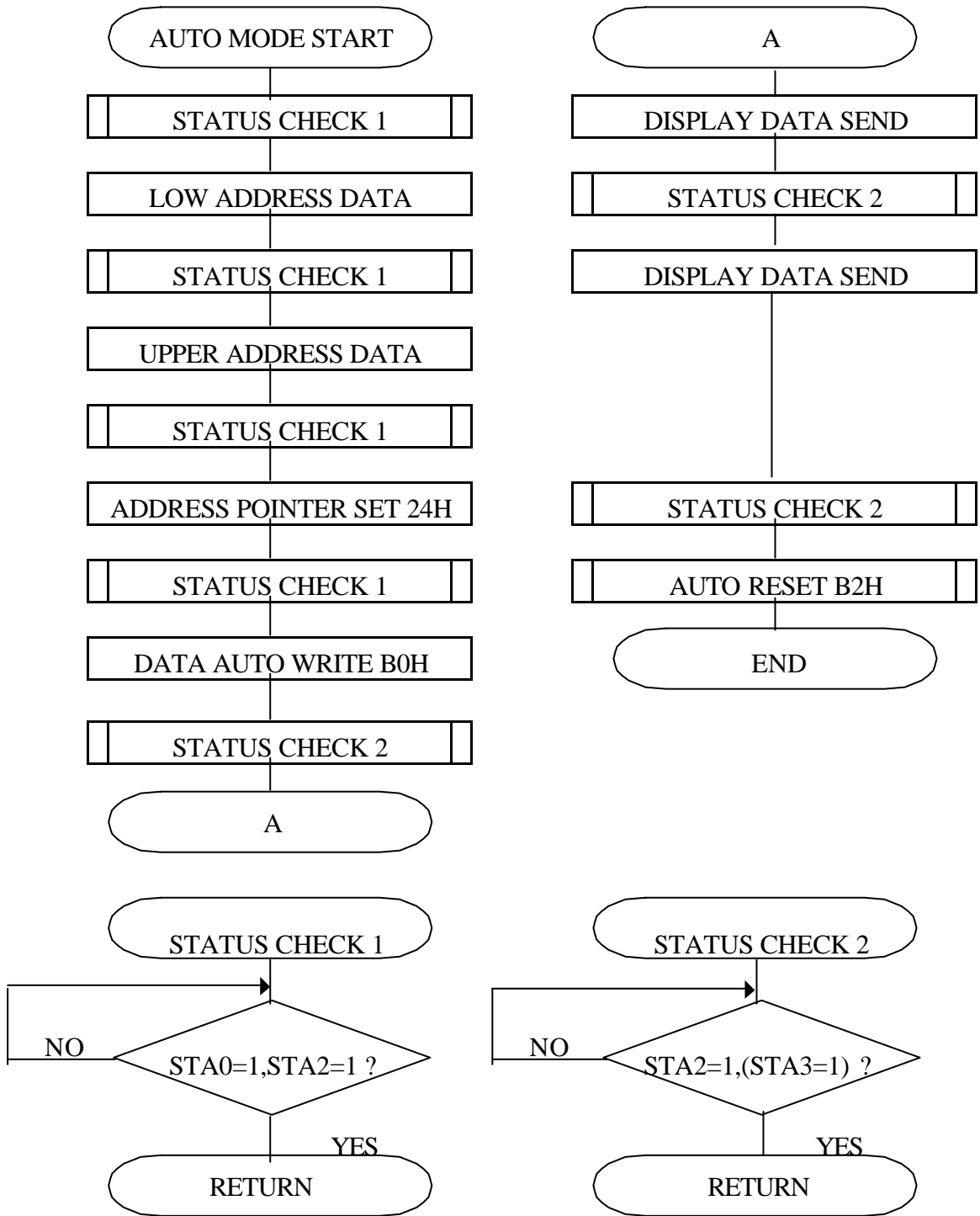
After setting auto mode, “Data write (or read)” command is not necessary between each data. “Data write (or read)” command should follow the “Address pointer set” and address pointer is automatically increment by + 1 after each data. After sending (or receiving) all data “Auto reset” is necessary to return normal operation because all data is regarded “Display data” and no command can be accepted in the auto mode.



Note : Status check for auto mode (STA2, STA should be checked between each data.

Auto reset should be performed after checking STA3=1 (STA2=1).

Please refer following flow chart.



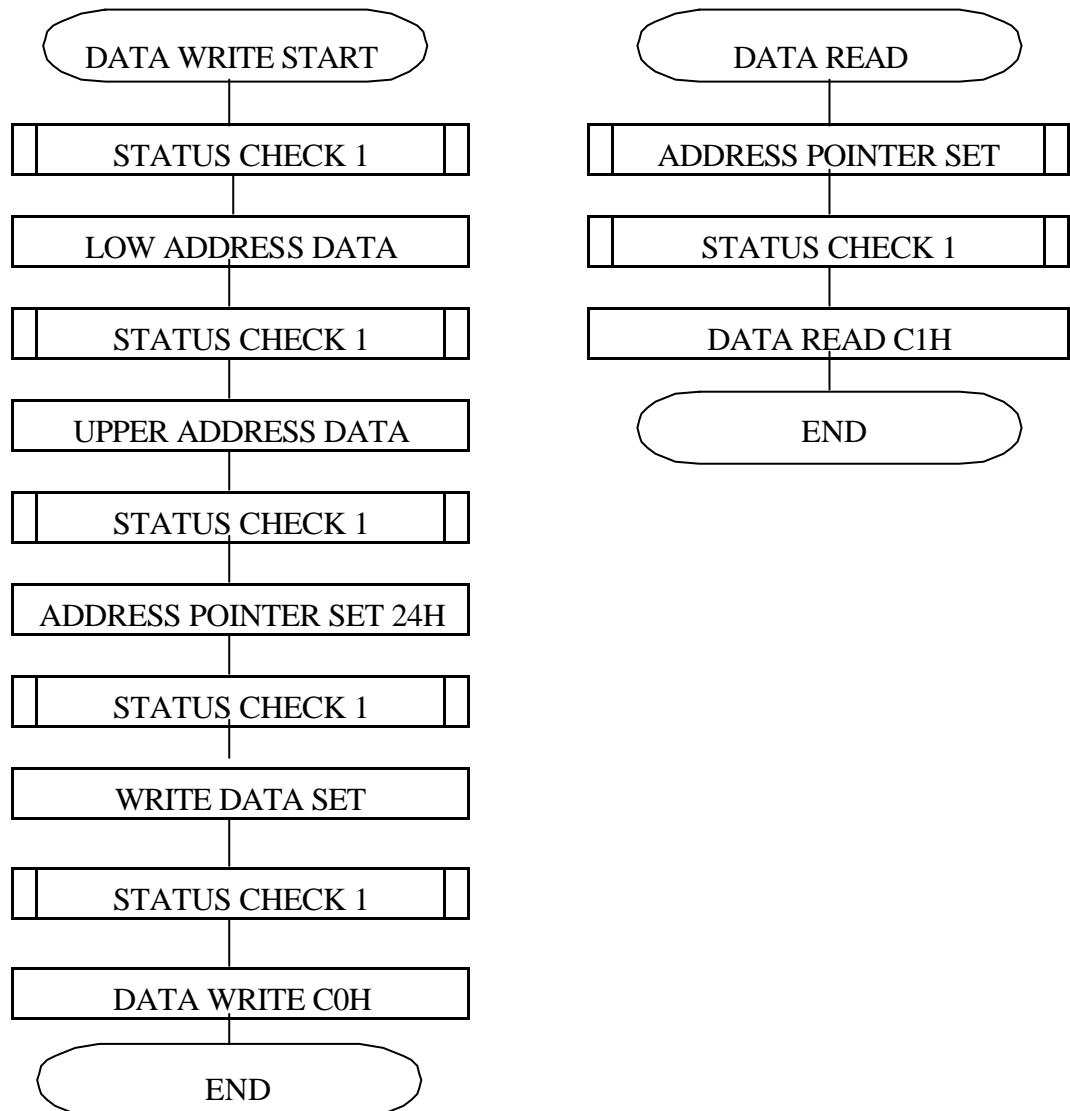
7.Data read write

Code	Hex.	Function	Operand
11000000	C0H	Data write and ADP increment	Data
11000001	C1H	Data read and ADP increment	-
11000010	C2H	Data write and ADP decrement	Data
11000011	C3H	Data read and ADP decrement	-
11000100	C4H	Data write and ADP nonvariable	Data
11000101	C5H	Data read and ADP nonvariable	-

This command is used for data write from MPU to external display RAM, and data read from external display RAM to MPU. Data write/data read should be executed after setting address by address pointer set command. Address pointer can be automatically increment or decrement by setting this command.

Note: This command is necessary for each 1 byte data.

Please refer following flow chart.



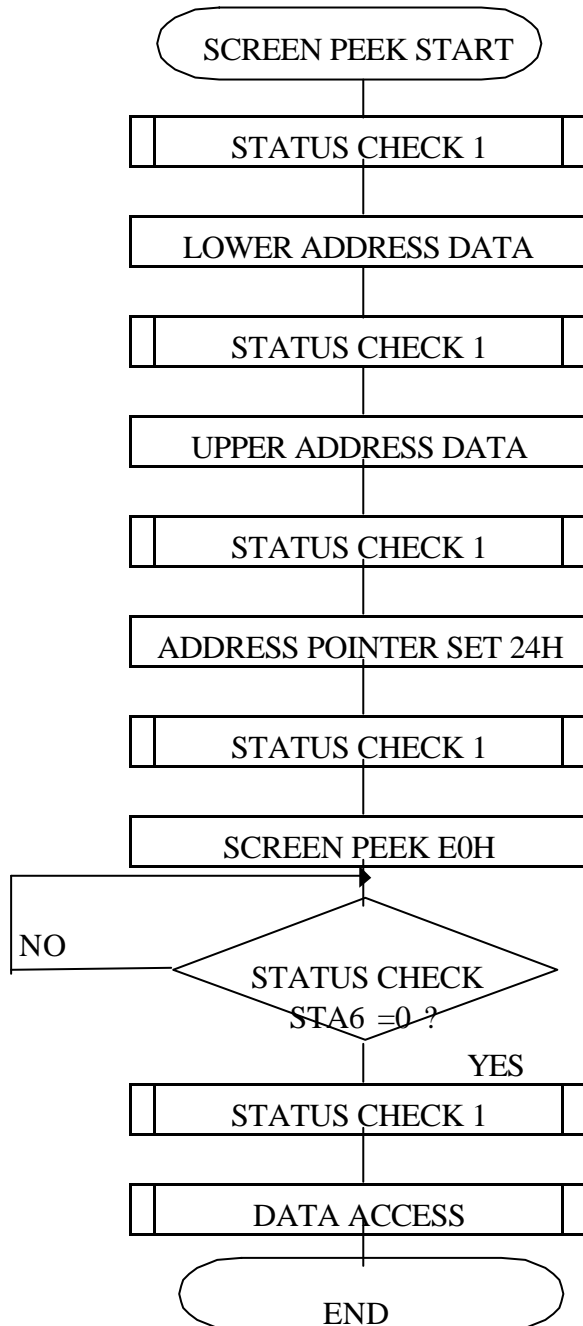
8.Screen peek

Code	Hex.	Function	Operand
11100000	E0H	screen peek	-

This command is used to transfer displayed 1 byte data to data stack, and this 1 byte data can be read from MPU by data access. The logical combination data of text and graphic display on LCD screen can be read by this command.

The status (STA6) should be checked just after “Screen peek” command. If the address determined by “Address pointer set” command is not in graphic area, this command ignored and status flag (STA6) is set.

Please refer following flow chart.



9.Screen copy

Code	Hex.	Function	Operand
11101000	E8H	screen copy	-

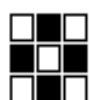
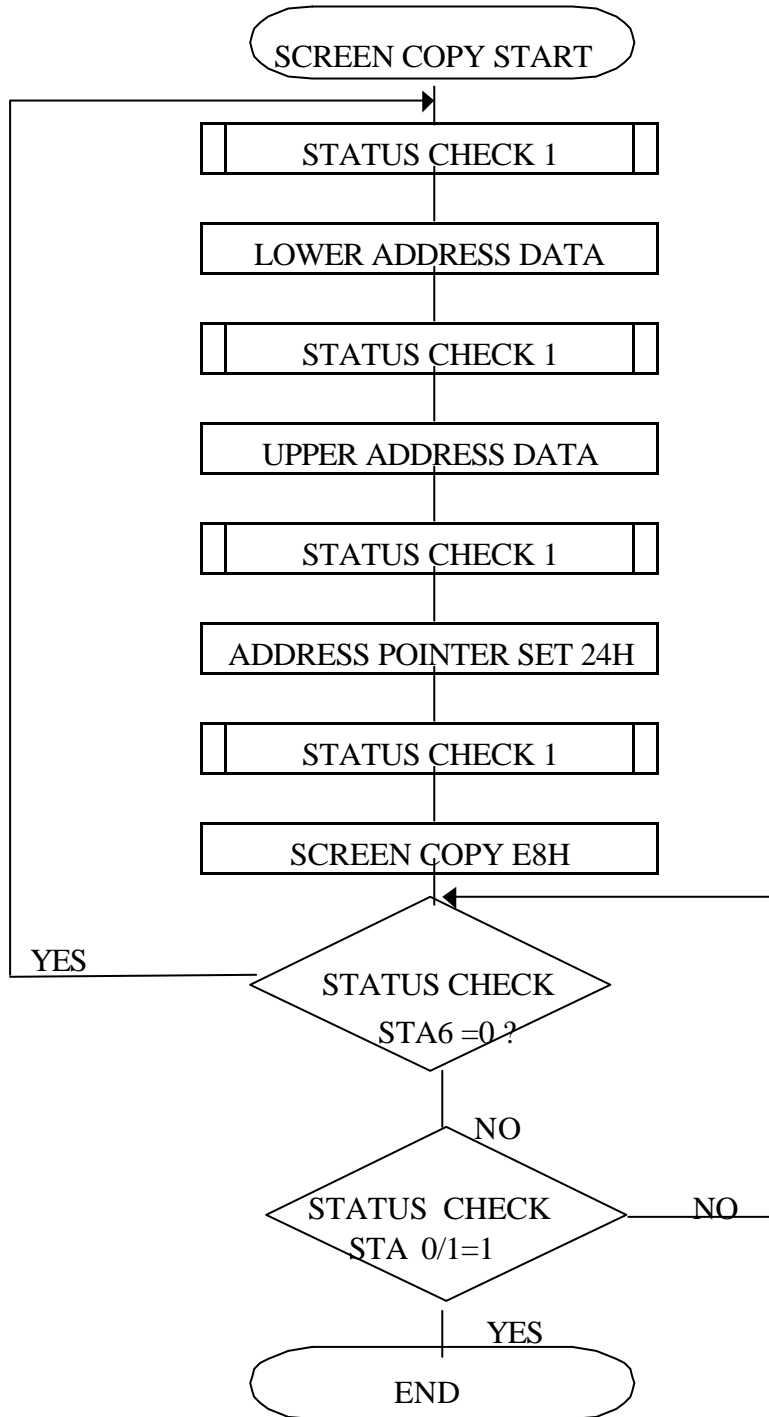
This command is used to copy displayed 1 line data to graphic area. The start point of 1 line data in the screen is determined by the address pointer.

Note: (1) In attribute function, this command is invalid.

(Because attribute data is in the graphic area.)

(2) In case of 2 screen drive, this command is invalid. (Because T693C cannot separate upper screen data and lower screen data.)

Please refer following flow chart.

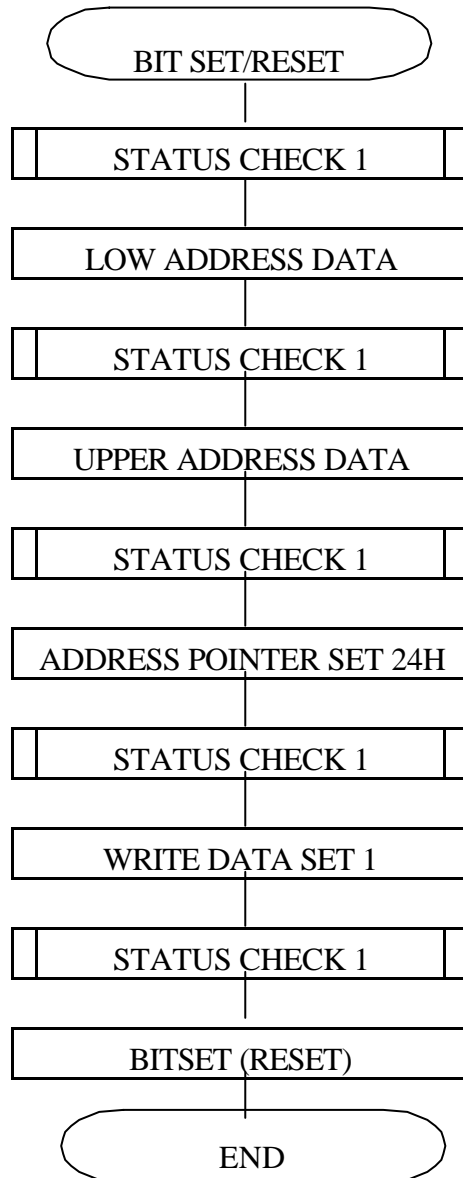


10.Bit set/reset

Code	Function	Operand
11110xxx	bit reset	-
11111xxx	bit set	-
1111x000	bit 9 (LSB)	-
1111x001	bit 1	-
1111x010	bit 2	-
1111x011	bit 3	-
1111x100	bit 4	-
1111x101	bit 5	-
1111x110	bit 6	-
1111x111	bit 7 (MSB)	-

This command is used to set or reset a bit of 1 byte is specified by address pointer. Plural bits in the 1 byte data cannot be set/reset at a time.

Please refer following flow chart.



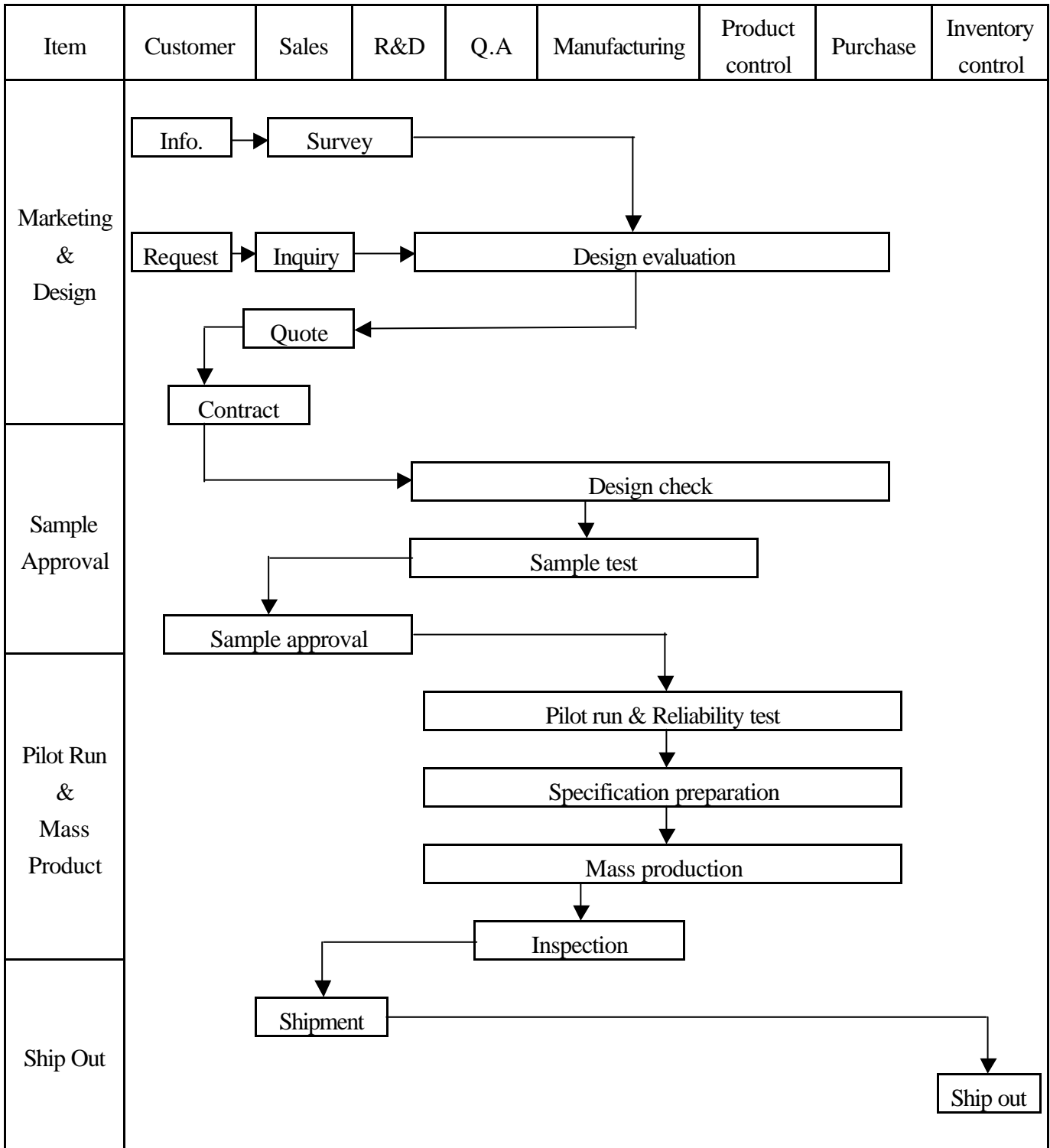
•Command list

Command	Code	D1	D2	Function
Register Set	00100001	X address	Y address	Cursor pointer set
	00100010	Data	00H	Offset register set
	00100100	Low address	High address	Address pointer set
Control Word Set	01000000	Low address	High address	Text home address set
	01000001	Columns	00H	Text area set
	01000010	Low address	High address	Graphic home address set
	01000011	Columns	00H	Graphic area set
Mode Set	1000x000	-	-	“OR” mode
	1000x001	-	-	“EXOR” mode
	1000x011	-	-	“AND” mode
	1000x100	-	-	“Text attribute” mode
	10000xxx	-	-	“Internal CG ROM mode
	10001xxx	-	-	“External CG CG RAM mode
Display Mode	10010000	-	-	Display off
	1001xx10	-	-	Cursor on, blink off
	1001xx11	-	-	Cursor on, blink on
	100101xx	-	-	Text on, graphic off
	100110xx	-	-	Text off, graphic on
	100111xx	-	-	Text on, graphic on
Cursor Pattern Select	10100000	-	-	1 line cursor
	10100001	-	-	2 lines cursor
	10100010	-	-	3 lines cursor
	10100011	-	-	4 lines cursor
	10100100	-	-	5 lines cursor
	10100101	-	-	6 lines cursor
	10100110	-	-	7 lines cursor
	10100111	-	-	8 lines cursor
Data Auto Read/Write	10110000	-	-	Data auto write set
	10110001	-	-	Data auto read set
	10110010	-	-	Auto reset
Data Read Write	11000000	Data	-	Data write and ADP increment
	11000001	-	-	Data read and ADP increment
	11000010	Data	-	Data write and ADP decrement
	11000011	-	-	Data read and ADP decrement
	11000100	Data	-	Data write and ADP nonvariable
	11000101	-	-	Data read and ADP nonvariable
Screen Peek	11100000	-	-	Screen peek
Screen Copy	11101000			Screen copy
Bit Set/Reset	11110xxx	-	-	bit reset
	11111xxx	-	-	bit set
	1111x000	-	-	bit0 (LSB)
	1111x001	-	-	bit1
	1111x010	-	-	bit2
	1111x011	-	-	bit3
	1111x100	-	-	bit4
	1111x101	-	-	bit5
	1111x110	-	-	bit6
	1111x111	-	-	bit7 (MSB)



3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



<p>Sales Service</p>	<pre> graph TD Info[Info.] --> Claim[Claim] Claim --> Failure[Failure analysis] Claim --> Report[Analysis report] Failure --> Action[Corrective action] Action --> Tracking[Tracking] </pre>
<p>Q.A Activity</p>	<ol style="list-style-type: none"> 1. ISO 9001 Maintenance Activities 2. Process improvement proposal 3. Equipment calibration 4. Education And Training Activities 5. Standardization Management



3.2 Inspection Specification

Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level

Equipment : Gauge、MIL-STD、Powertip Tester、Sample。

IQC Defect Level : Major Defect AQL 0.65; Minor Defect AQL 1.0。

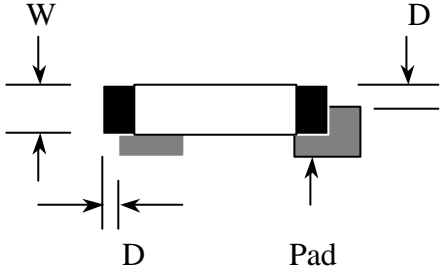
FQC Defect Level : 100% Inspection。

OUT Going Defect Level : Sampling。

Specification :

N O	Item	Specification	Judge	Level
1	Part Number	Inconsistent with the P/N on the flow chart of production	N.G.	Major
2	Quantity	Inconsistent Q'TY with the flow chart of production	N.G.	Major
3	Electronic characteristics $A=(L+W) \div 2$	Display short	N.G.	Major
		Missing line	N.G.	Major
		Dot missing $A > 1/2$ Dot size	N.G.	Major
		No function	N.G.	Major
		Out put data error	N.G.	Major
4	Appearance $A=(L+W) \div 2$	Material difference with flow chart	N.G.	Major
		LCD Assembled in opposite direction	N.G.	Major
		Bezel assembled in opposite direction	N.G.	Major
		Shadow within LCD $V./A + 1.0$ mm	N.G.	Major
	Dirty particle (Include scratch, bubble)	Dirty particle $A > 0.4$ mm	N.G.	Minor
		Dirty particle length > 3.0 mm And $0.01\text{mm} < \text{Width} < 0.05\text{mm}$ (Width $> 0.05\text{mm}$ Measure by area)	N.G.	Minor
		Without protective film	N.G.	Minor
		Conductive rubber over bezel	N.G.	Minor
5	PCB Appearance $A=(L+W) \div 2$	Burned PCB	N.G.	Major
		Green paint stripped & visible circuit $A > 1.0$ mm (Finish coat not counted in)	N.G.	Minor
		A particle across the circuit	N.G.	Minor
		Circuit split $> 1/2$ Circuit width	N.G.	Minor
		Any circuit risen	N.G.	Minor
		$0.2\text{mm} < \text{Tin ball area} A < 0.4\text{mm}$ And Q'TY > 4 Pieces	N.G.	Minor
		Tin ball area $A > 0.4\text{mm}$	N.G.	Minor



N O	Item	Specification	Judge	Level
6	Molding appearance $A=(L+W) \div 2$	Too soft : Shape by touch changed	N.G.	Major
		Insufficient epoxy : IC circuit or IC pad visible	N.G.	Minor
		Excessive epoxy : Diameter > 20mm Or High > 2.5mm	N.G.	Minor
		Pin hole through to IC and A > 0.2mm	N.G.	Minor
7	Bezel appearance $A=(L+W) \div 2$	Angle between frame and TAB > 45 +10	N.G.	Minor
		Electroplate strip A > 1.0mm (Top view only)	N.G.	Minor
		Rust (Top view only)	N.G.	Minor
		Crack	N.G.	Minor
8	Backlight electric characteristics $A=(L+W) \div 2$	Error backlight color	N.G.	Major
		No function	N.G.	Major
		Any LED dot no function	N.G.	Major
		PIN soldering without tin A > 1/2 solder pad	N.G.	Minor
		Solder PIN high > 1.5mm	N.G.	Minor
9	LCD Appearance $A=(L+W) \div 2$	Polarize rise over V/A	N.G.	Minor
10	Assembly parts $A=(L+W) \div 2$	Components mark unclearly	N.G.	Minor
		Components' distance more than 0.7mm firm the PCB	N.G.	Minor
		Error position ,not in center $D > 1/4W$	N.G.	Minor
				
		Non- solder area > Twice solder area	N.G.	Minor
		Flux area A > 1/4 solder area	N.G.	Minor
		Component broken	N.G.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

NO	Item	Test Condition	Applicable Standard	
1	High Temperature Storage	Storage At 80 ± 2 96~100 hrs Surrounding Temperature , Then Storage At Normal Condition 4hrs.	MIL-202E	
2	Low Temperature Storage	Storage At -30 ± 2 96~100 hrs Surrounding Temperature, Then Storage At Normal Condition 4hrs.	MIL-202E	
3	High Temperature Humidity Storage	1.Storage 96~100 hrs 60 ± 2 , 90~95%RH Surrounding Temperature, Then Storage At Normal Condition 4hrs .(Polarizer may fail in this environment). or 2.Storage 96~100 hrs 40 ± 2 , 90~95%RH Surrounding Temperature, Then Storage At Normal Condition 4 hrs.	MIL-202E	
4	Temperature Cycling	-20 25 70 25 (30Mins) (5Mins) (30Mins) (5Mins) 10 Cycle	MIL-202E	
5	Vibration	10~55Hz (1 Minute) 1.5mm X,Y And Z Direction * (Each 2hrs)	MIL-202E	
6	Drop Test	Packing Weight (Kg)	Drop High (Cm)	MIL-810E
		0 ~ 45.4	122	
		45.4 ~ 90.8	76	
		90.8 ~ 454	61	
		Over 454	46	



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully , do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25 ± 5 and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.



5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company' s specification as a part for use in your company' s general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in medical devices , nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

